FP1208

High frequency, high current power inductors





Product features

- 12.1x8.0x8.0mm maximum surface mount package
- Ferrite core material
- · Controlled DCR for sensing circuits
- Inductance range from 150nH to 250nH
- Current range from 44 to 85 Amps
- · Halogen free, lead free, RoHS compliant

Applications

- Multi-phase regulators
- Voltage Regulator Modules (VRMs)
- Desktop and server VRMs and EVRDs
- Data networking and storage systems
- · Graphics cards and battery power systems
- Point-of-Load modules
- DCR Sensing circuits

Environmental data

- Storage temperature range (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature:
 J-STD-020 (latest revision) compliant







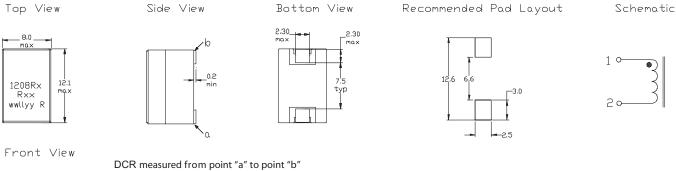


Product Specifications								
Part	OCL 1	FLL min. ²	I _{rms} ³	I _{sat} 1 ⁴	I _{sat} 25	I _{sat} 36	DCR	
Number ⁸	(nH)±10%	(nH)	(Amps)	(Amps)	(Amps)	(Amps)	(mΩ) @ 20°C	K-factor 7
FP1208R1-R15-R	150	114		85	79	72		283
FP1208R1-R18-R	180	137		72	66	63		283
FP1208R1-R21-R	210	160	50	65	57	55	0.29±5%	283
FP1208R1-R23-R	230	176		61	53	50		283
FP1208R1-R25-R	250	191		55	48	44		283

- 1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1Vrms, 0.0Adc@25°C
- . 2. Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1 V_{rms} , I_{sat1}
- 3. lrms: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 4. I_{Sat}1: Peak current for approximately 20% rolloff @ 25°C

- 5. Isat2: Peak current for approximately 20% rolloff @ 85°C
- 6. Isat3: Peak current for approximately 20% rolloff @ 125°C
- 7. K-factor: Used to determine Bp-p for core loss (see graph). B_{p-p} = K * L
- * Δl * $10^{-3}.$ Bp-p:(Gauss), K: (K-factor from table), L: (Inductance in nH), ΔI (Peak to peak ripple current in Amps).
- 8. Part Number Definition: FP1208Rx-Rxx-R:
- FP1208= Product code and size
- Rx= DCR indicator
- Rxx= Inductance value in μH
- "-R" suffix = RoHS compliant

Dimensions- mm





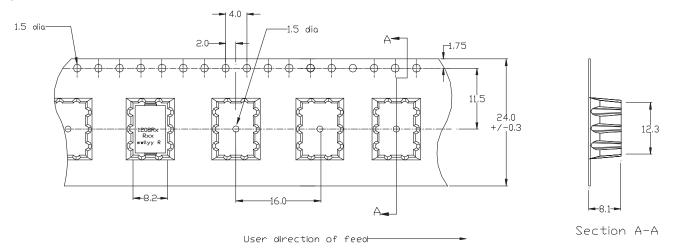
Part marking: 1208Rx (Rx= DCR indicator), Rxx = Inductance value in uH (R= decimal point) wwllyy= date code, r= revision level

Tolerances are +/- 0.15 millimeters unless stated otherwise.

PCB tolerances are +/- 0.10 millimeters unless stated otherwise.

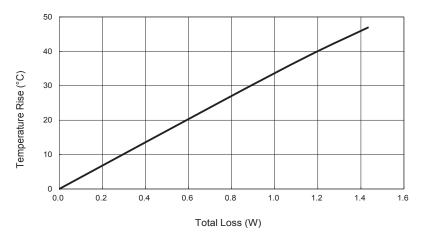
All soldering surfaces to be be coplanar within 0.1 millimeters.

Packaging information - mm

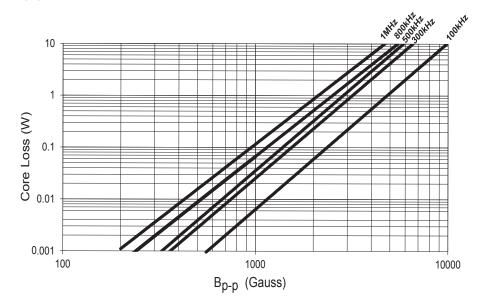


Supplied in tape and reel packaging, 500 parts on a 13" diameter reel.

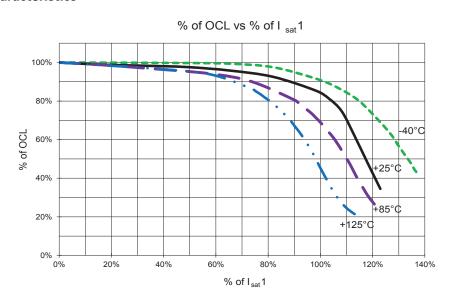
Temperature rise vs total loss



Core loss vs Bp-p



Inductance characteristics



Solder Reflow Profile

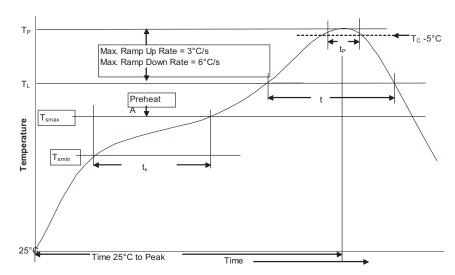


Table 1 - Standard SnPb Solder (T_c)

	Volume	Volume
Package	mm³	mm³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package	Volume mm³	Volume mm³	Volume mm³
Thickness	<350	350 - 2000	>2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	• Temperature min. (T _{smin})	100°C	150°C	
	Temperature max. (T _{smax})	150°C	200°C	
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{Smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (Tp)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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